Linear Single Cell Li-Ion Battery Charger IC

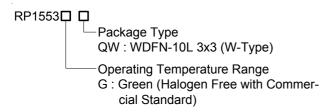
General Description

The RP1553 is a fully integrated low cost single-cell Lilon battery charger IC ideal for portable applications. The RP1553 is capable of being powered up from AC adapter. The RP1553 enters sleep mode when AC adapter is removed.

The RP1553 optimizes the charging task by using a control algorithm including preconditioning mode, fast charge mode and constant voltage mode. The charging task is terminated as the charge current drops below the preset threshold. The AC adapter charge current can be programmed up to 1A with an external resister. The internal thermal feedback circuitry regulates the die temperature to optimize the charge rate for all ambient temperatures.

The RP1553 features 18V maximum rating voltages for AC adapter. The other features are under voltage protection, over voltage protection for AC adapter supply and battery temperature monitoring.

Ordering Information



Note:

Richpower Green products are :

- RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶ Suitable for use in SnPb or Pb-free soldering processes.

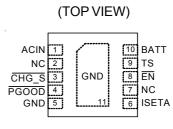
Features

- 18V Maximum Rating for AC Adapter
- Internal Integrate P-MOSFETs
- AC Adapter Power Good Status Indicator
- Charge Status Indicator
- Under Voltage Protection
- Over Voltage Protection
- Automatic Recharge Feature
- Battery Temperature Monitoring
- Small 10-Lead WDFN Package
- Thermal Feedback Optimizing Charge Rate
- RoHS Compliant and 100% Lead (Pb)-Free

Applications

- Digital Cameras
- Cellular Phones
- Personal Data Assistants (PDAs)
- MP3 Players
- Hand Held PCs

Pin Configurations



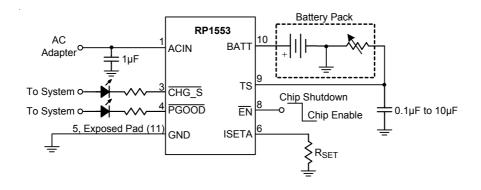
WDFN-10L 3x3

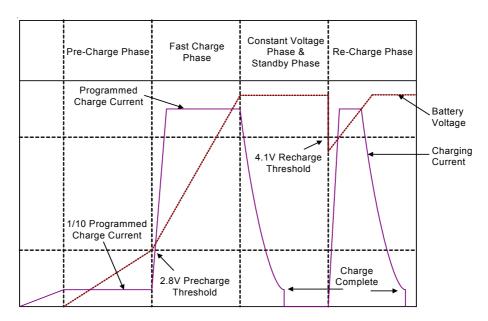
Marking Information

For marking information, contact our sales representative directly or through a Richpower distributor located in your area, otherwise visit our website for detail.



Typical Application Circuit



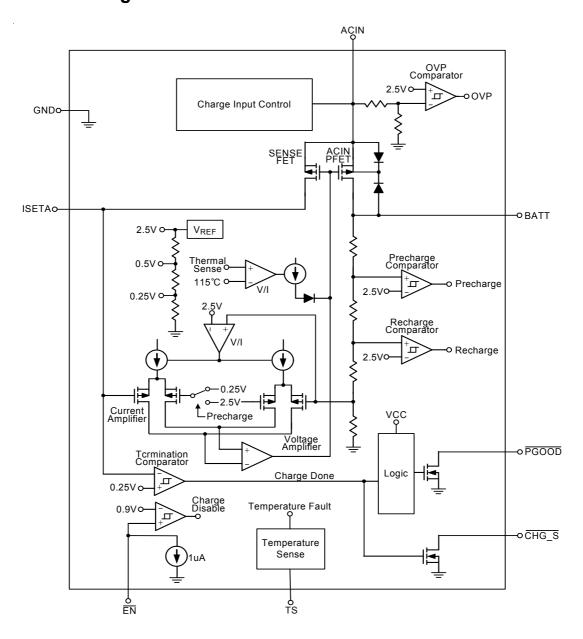


Functional Pin Description

Pin No.	Pin Name	Pin Function
1	ACIN	Wall Adaptor Charge Input Supply.
2, 7	NC	No Internal Connection.
3	CHG_S	Charge Status Indicator Output (open drain).
4	PGOOD	Power Good Indicator Output (open drain).
5	GND	Ground.
6	ISETA	Wall Adaptor Supply Charge Current Set Point.
8	EN	Charge Enable Input (active low).
9	TS	Temperature Sense Input.
10	BATT	Battery Charge Current Output.
11 (Exposed Pad)	GND	Exposed pad should be soldered to PCB board and connected to GND.



Function Block Diagram

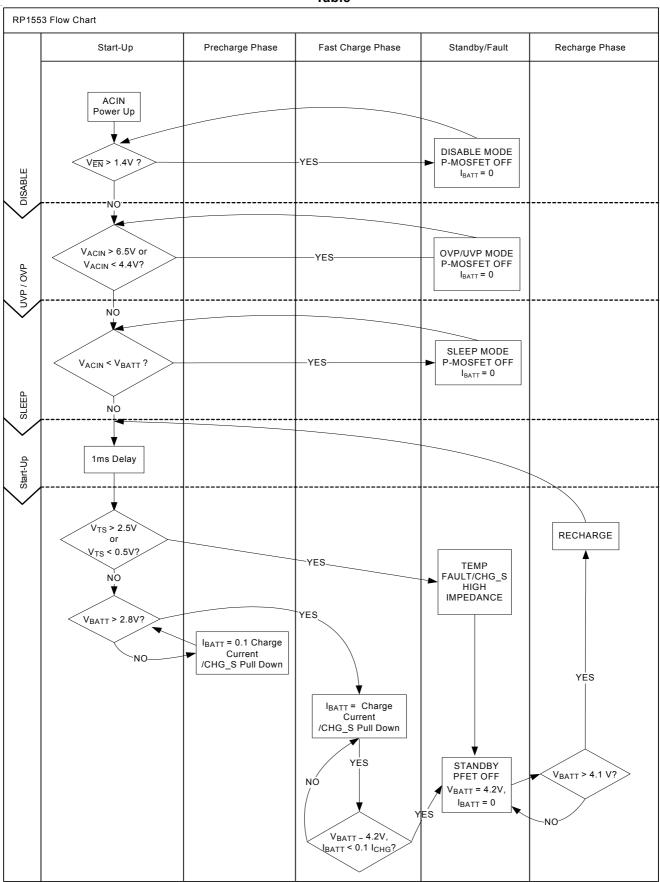


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Table



Absolute Maximum Ratings (Note 1)

• ACIN Input Voltage	0.3V to 18V
• EN Input Voltage	- −0.3V to 6V
• Output Current	- 1.2A
 Power Dissipation, P_D @ T_A = 25°C 	
WDFN-10L 3x3	- 0.926W
Package Thermal Resistance (Note 4)	
WDFN-10L 3x3, θ_{JA}	- 108°C/W
WDFN-10L 3x3, θ_{JC}	- 8.2°C/W
• Lead Temperature (Soldering, 10 sec.)	- 260°C
• Junction Temperature	- 150°C
Storage Temperature Range	65°C to 150°C
ESD Susceptibility (Note 2)	
HBM (Human Body Mode)	- 2kV
MM (Machine Mode)	- 200V
Recommended Operating Conditions (Note 3)	

• ACIN Input Voltage Range ----- 4.5V to 6V

Electrical Characteristics

(ACIN = 5V, T_A = 27°C, Unless Otherwise specification)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units	
Supply Input							
ACIN UVP Rising Threshold Voltage	V _{UV_HIGH}			4.4	4.5	V	
ACIN UVP Hysteresis	V _{UV_LOW}		50	80	120	mV	
ACIN Standby Current	I _{STBY}	V _{BATT} = 4.5V		300	500	μΑ	
ACIN Shutdown Current	I _{SHDN}	V _{EN} = HIGH		50	100	μΑ	
ACIN UVP Current	l _{UVP}	V _{ACIN} = 4V, V _{USB} = 4V, V _{BATT} = 3V		150	250	μΑ	
BATT Sleep Leakage Current	I _{SLEEP}	V_{ACIN} = 4V, V_{USB} = 4V, V_{BATT} = 4.5V		2	5	μA	
Voltage Regulation							
BATT Regulation Voltage	V_{REG}	I _{BATT} = 60mA	4.158	4.2	4.242	V	
Regulation Voltage Accuracy			-1	-	+1	%	
ACIN MOSFET	R _{DS(ON)_ACIN}	I _{BATT} = 500mA		600		mΩ	
Current Regulation							
ISETA Set Voltage (Fast Charge Phase)	V _{ISETA}	V _{BATT} = 3.5V	2.45	2.5	2.55	V	
Full Charge Setting Range	I _{CHG_AC}		100		1200	mA	
ACIN Charge Current accuracy	I _{CHG_AC}	$V_{BATT} = 3.8V$, $R_{ISET} = 1.5k\Omega$		500		mA	

To be continued

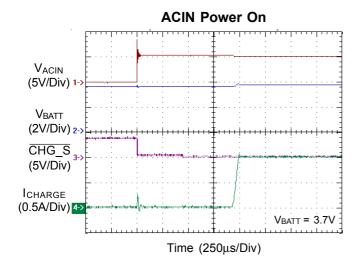


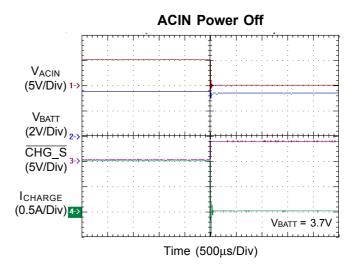
Parameter		Symbol	Test Conditions	Min	Тур	Max	Units
Precharge							
BATT Pre-Charge Rising Threshold		V _{PRECH}		2.6	2.8	3	V
BATT Pre-Charge Threshold Hysteresis		ΔV_{PRECH}		50	100	200	mV
Pre-Charge Curr	ent	I _{PCHG}	V _{BATT} = 2V	8	10	12	%
Recharge Thres	shold						
BATT Re-Charge Falling Threshold Hysteresis		ΔV_{RECH_L}	V _{REG} – V _{BATT}	60	100	150	mV
Charge Termina	ation Detection						
ISETA Charge Termination Set Voltage		V_{TERM}	V _{BATT} = 4.2V	225	250	275	mV
Termination Curr	ent Ratio (default)	I _{TERM}	V _{BATT} = 4.2V		10		%
Logic Input/Out	put						
CHG_S Pull Down Voltage		V _{CHG_S}	TBD, I _{CHG_S} = 5mA		65		mV
PGOOD Pull Dov	wn Voltage	V PGOOD	TBD, IPGOOD = 5mA		220		mV
EN Threshold	Logic-High Voltage	V _{IH}		1.5			V
LIV IIII GOIIGIG	Logic-Low Voltage	V_{IL}				0.4	V
EN Pin Input Cur	rent	IEN	V _{EN} = 2V			2	μΑ
Battery Temper	ature Sense						
TS Pin Source Current		I _{TS}	V _{TS} = 1.5V	96	102	108	μΑ
TS Pin Threshold	Low Voltage	V _{TS_LOW}	Falling	0.485	0.5	0.515	V
	High Voltage	V _{TS_HIGH}	Rising	2.45	2.5	2.55	V
Protection							
Thermal Regulation					125		°C
OVP SET			Internal Default		6.5		V

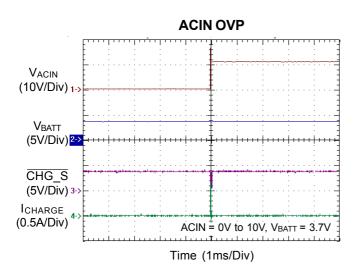
- **Note 1.** Stresses listed as the above "Absolute Maximum Ratings" may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may remain possibility to affect device reliability.
- Note 2. Devices are ESD sensitive. Handling precaution is recommended.
- Note 3. The device is not guaranteed to function outside its operating conditions.
- Note 4. θ_{JA} is measured in the natural convection at T_A = 25°C on a high effective thermal conductivity test board (4 layers, 1S) of JEDEC 51-7 thermal measurement standard. The case point of θ_{JC} is on the expose pad for the WDFN package.

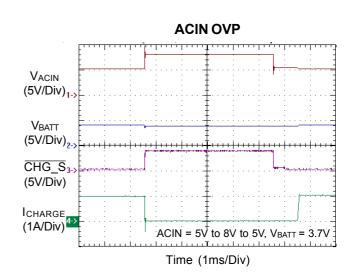


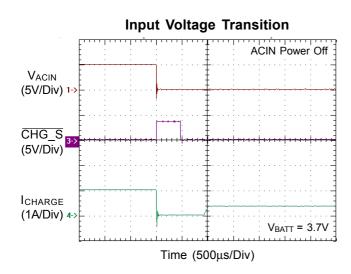
Typical Operating Characteristics

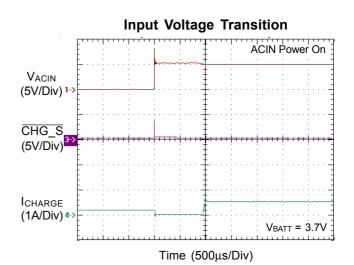












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Application Information

Automatically Power Source Selection

The RP1553 is a battery charger IC which is designed for Li-ion Battery with 4.2V rated voltage.

ACIN Mode: When the ACIN input voltage is higher than the UVP voltage level (4.4V), the RP1553 will turn on ACIN P-MOSFET.

Sleep Mode: The RP1553 will enter Sleep Mode when ACIN input voltage are removed. This feature provides low leakage current from the battery during the absence of input supply.

ACIN Over Voltage Protection

The ACIN input voltage is monitored by an internal OVP comparator. The comparator has an accurate reference of 2.5V from the band-gap reference. The OVP threshold is set by the internal resistive. The protection threshold is set to 6.5V. When the input voltage exceeds the threshold, the comparator outputs a logic signal to turn off the power P-MOSFET to prevent the high input voltage from damaging the electronics in the handheld system. When the input over oltage condition is removed (ACIN < 6V), the comparator re-enables the output by running through the soft-start.

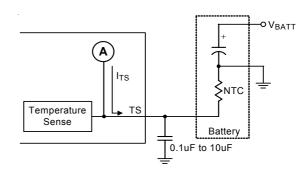
Battery Temperature Monitoring

The RP1553 continuously monitors battery temperature by measuring the voltage between the TS and GND pins. The RP1553 has an internal current source to provide the bias for the most common $10k\Omega$ negative-temperature coefficient thermal resistor (NTC) (see Figure 1). The RP1553 compares the voltage on the TS pin against the internal VTS_HIGH and VTS_LOW thresholds to determine if charging is allowed.

When the temperature outside the VTS_HIGH and VTS_LOW thresholds is detected, the device will immediately stop the charge. The RP1553 stops charge and keep monitoring the battery temperature when the temperature sense input voltage is back to the threshold between VTS_HIGH and VTS_LOW, the charger will be resumed. Charge is resumed when the temperature returns to the normal range. However the user may modify thresholds by the negative-temperature coefficient thermal

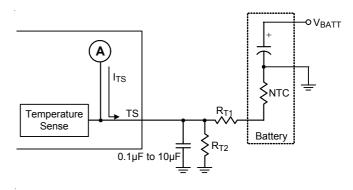
resistor or adding two external resistors. (see Figure 2.)

The capacitor should be placed close to TS(Pin 9) and connected to the ground plane. The capacitance value $(0.1\mu F$ to $10\mu F)$ should be selected according to the quality of PCB layout. It is recommended to use $10\mu F$ if the layout is poor if prevent noise.



 $V_{TS} = I_{TS} \times R_{NTC}$ Turn off when $V_{TS} \ge 2.5 V$ or $V_{TS} \le 0.5 V$

Figure 1. Temperature Sensing Configuration



$$\begin{aligned} V_{TS} &= I_{TS} \frac{R_{T2} \times (R_{T1} + R_{NTC})}{R_{T1} + R_{T2} + R_{NTC}} \\ &\text{Turn off when } V_{TS} \geq 2.5 \text{V or } V_{TS} \leq 0.5 \text{V} \end{aligned}$$

Figure 2. Temperature Sensing Circuit

Fast-Charge Current Setting

The RP1553 offers ISETA pin to determine the ACIN charge rate from 100mA to 1.2A. The charge current can be calculated as following equation.

$$I_{charge_ac} = K_{SET} \frac{V_{SET}}{R_{SETA}}$$



The parameter K_{SET} = 300 ; V_{SET} = 2.5V. R_{SETA} is the resistor connected between the ISETA and GND.

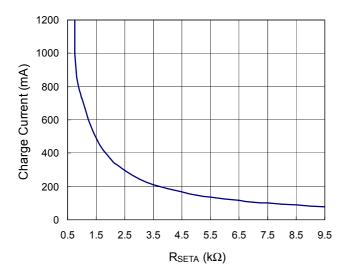


Figure 3. ACIN Mode Charge Current Setting

Pre- Charge Current Setting

During a charge cycle if the battery voltage is below the VPRECH threshold, the RP1553 applies a pre-charge mode to the battery. This feature revives deeply discharged cells and protects battery life. The RP1553 internal determines the pre-charge rate as 10% of the fast-charge current.

Battery Voltage Regulation

The RP1553 monitors the battery voltage through the BATT pin. Once the battery voltage level closes to the VREG threshold, the RP1553 voltage enters constant phase and the charging current begins to taper down. When battery voltage is over the VREG threshold, the RP1553 will stop charge and keep to monitor the battery voltage. However, when the battery voltage decreases 100mV below the V_{REG} , it will be recharged to keep the battery voltage.

Charge Status Outputs

The open-drain CHG_S and PGOOD outputs indicate various charger operations as shown in the following table.

These status pins can be used to drive LEDs or communicate to the host processor. Note that ON indicates the open-drain transistor is turned on and LED is bright.

Charge State		CHG_S	PGOOD	
ACIN	Charge	ON	ON	
	Charge done	OFF	ON	

Temperature Regulation and Thermal Protection

In order to maximize the charge rate, the RP1553 features a junction temperature regulation loop. If the power dissipation of the IC results in a junction temperature greater than the thermal regulation threshold (125°C), the RP1553 throttles back on the charge current in order to maintain a junction temperature around the thermal regulation threshold (125°C). The RP1553 monitors the junction temperature, $T_{\rm J},$ of the die and disconnects the battery from the input if $T_{\rm J}$ exceeds 125°C. This operation continues until junction temperature falls below thermal regulation threshold (125°C) by the hysteresis level. This feature prevents the chip from damage.

Selecting the Input and Output Capacitors

In most applications, the most important is the high-frequency decoupling capacitor on the input of the RP1553. A $1\mu F$ ceramic capacitor, placed in close proximity to input pin and GND pin is recommended. In some applications depending on the power supply characteristics and cable length, it may be necessary to add an additional $10\mu F$ ceramic capacitor to the input. The RP1553 requires a small output capacitor for loop stability. A $1\mu F$ ceramic capacitor placed between the BATT pin and GND is typically sufficient.

Layout Consideration

The RP1553 is a fully integrated low cost single-cell Lilon battery charger ideal for portable applications. Careful PCB layout is necessary. For best performance, place all peripheral components as close to the IC as possible. A short connection is highly recommended. The following guidelines should be strictly followed when designing a PCB layout for the RP1553.

▶ Input capacitor should be placed close to IC and connected to ground plane. The trace of input in the PCB should be placed far away the sensitive devices or shielded by the ground.

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- ▶ The GND should be connected to a strong ground plane for heat sinking and noise protection.
- ▶ The connection of R_{SETA} should be isolated from other noisy traces. The short wire is recommended to prevent EMI and noise coupling.
- ▶ Output capacitor should be placed close to IC and connected to ground plane to reduce noise coupling.
- ▶ The TS's capacitor should be placed close to TS (Pin 9) and connected to ground plane. The capacitance (0.1μF to 10μF) base on PCB layout. When PCB has poor layout, the 10μF is recommended to prevent noise.

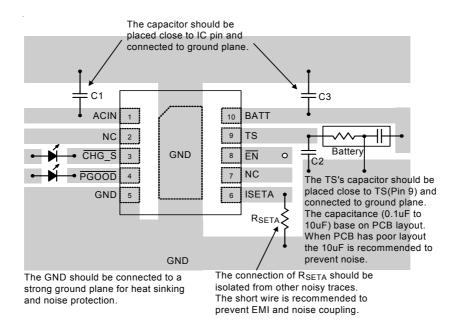
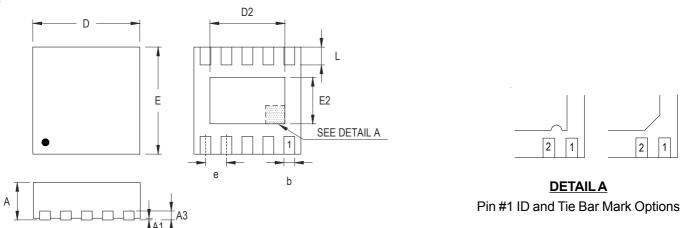


Figure 4

Outline Dimension



: The configuration of the Pin #1 identifier is optional, but must be located within the zone indicated.

Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
	Min	Max	Min	Max	
А	0.700	0.800	0.028	0.031	
A1	0.000	0.050	0.000	0.002	
A3	0.175	0.250	0.007	0.010	
b	0.180	0.300	0.007	0.012	
D	2.950	3.050	0.116	0.120	
D2	2.300	2.650	0.091	0.104	
Е	2.950	3.050	0.116	0.120	
E2	1.500	1.750	0.059	0.069	
е	0.5	500	0.0)20	
L	0.350	0.450	0.014	0.018	

W-Type 10L DFN 3x3 Package

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